

Call for Paper

CADME 2007

Conference on Applications and Design in Mechanical Engineering, Universiti Malaysia Perlis (UniMAP) Kangar, Malaysia, 25-26 October 2007 is intended to provide a common platform for knowledge sharing in the areas related to applications and design in Mechanical Engineering.

Scope (but not limited to) : Energy & Thermo-fluids, Energy Conversion System, Renewable Energy, Fluid Dynamics, Heat Transfer, Heat Exchanger, Refrigeration and Air Conditioning, Computational Fluid Dynamics (CFD), Applied Mechanics & Design, Solid & Fracture Mechanics, Dynamics of Machinery, Applied Mechanics, Condition Monitoring, Machine Design Engineering Design, Concurrent Engineering, Finite Element Analysis (FEA), Noise & Vibration Analysis, Automation & robotics, Biomechanics, Computer Aided, Engineering Design (CAED), Alternative Energy and Internal Combustion Engine.

CADME 2007 Secretariat, School of Mechatronics Engineering, Universiti Malaysia Perlis (UniMAP), Blok A, Kompleks Pusat Pengajian, Jalan Kangar-Arau, 02600 Jejawi, Perlis. MALAYSIA

Phone: +604 9798684, H/p: +6019 4783806,

Fax: +604 9798142

En. Shah Fenner Khan (shahfener@unimap.edu.my)

Cik Bibi Intan Suraya Murat (intansuraya@unimap.edu.my),

Pn. Hafizawati (hafizawati@unimap.edu.my)

<http://www.unimap.edu.my/cadme07>

Email: cadme07@unimap.edu.my

RSM 2007

The 2007 IEEE REGIONAL SYMPOSIUM ON MICROELECTRONICS is aimed to agglomerate researchers from industry and academia to gather and explore various issues and trends in the field of microelectronics and photonics.

Penang, December 5-7, 2007

Extended abstract due : September 3, 2007

Full paper due : October 1, 2007

RSM2007 is jointly organised by IEEE Malaysia Section, IEEE Electron Device Society, UKM, UniMAP and SilTerra (M) Sdn. Bhd.

This conference is a forum for papers on all aspects of microelectronics including:

Device physics, Device characterization and testing, Device modeling, simulation and design, Materials and new fabrication technologies for VLSI structures, VLSI and MMIC circuits design, Process technology, Advanced materials for semiconductor packaging, Microsensor devices, Application of microelectronics in product development, Micro-Electro-Mechanical System (MEMS), Reliability and failure analysis, Training and human resource development in microelectronics industry and Photonics.

RSM2007 Conference Secretariat

Electron Devices Chapter

IEEE Malaysia Section

Institute of Microengineering and Nanoelectronics (Photonic Section), Universiti Kebangsaan Malaysia, 43600 UKM, Bangi, Selangor Darul Ehsan, MALAYSIA

(Att. Hayati)

Tel : 603-89216320 (Hayati), 603-89216332 (Dr. Badariah)

Fax : 603-89259080

E-mail : eds@vlsi.eng.ukm.my

Conference Chairman : Prof. Dr. Sahbudin Shaari (UKM)

Tel : 03-89216308

E-mail : sahbudin@vlsi.eng.ukm.my